

SN74ACT16374Q-EP

16-BIT D-TYPE EDGE-TRIGGERED FLIP-FLOP WITH 3-STATE OUTPUTS

SCAS679B – MAY 2002 – REVISED JULY 2002

- **Controlled Baseline**
 - One Assembly/Test Site, One Fabrication Site
- **Extended Temperature Performance of –40°C to 125°C**
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product Change Notification**
- **Qualification Pedigree†**
- **Member of the Texas Instruments Widebus™ Family**
- **Inputs Are TTL-Voltage Compatible**
- **3-State Bus Driving True Outputs**
- **Flow-Through Architecture Optimizes PCB Layout**
- **Distributed V_{CC} and GND Pins Minimize High-Speed Switching Noise**

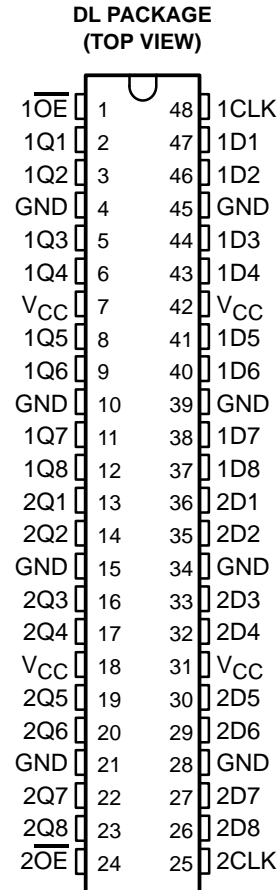
† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, highly accelerated stress test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life.

description

The SN74ACT16374Q-EP is a 16-bit edge-triggered D-type flip-flop with 3-state outputs, designed specifically for driving highly capacitive or relatively low-impedance loads. It is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

This device can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK) input, the Q outputs of the flip-flop take on the logic levels set up at the data (D) inputs.

An output-enable (\overline{OE}) input can be used to place the outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state provides the capability to drive bus lines in a bus-organized system, without need for interface or pullup components. \overline{OE} does not affect the internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.



ORDERING INFORMATION

| T _A | PACKAGE‡ | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------|-----------------------|--------------------|
| –40°C to 125°C | SSOP – DL | Tape and reel | SN74ACT16374QDLREP |
| | | | ACT16374QEP |

‡ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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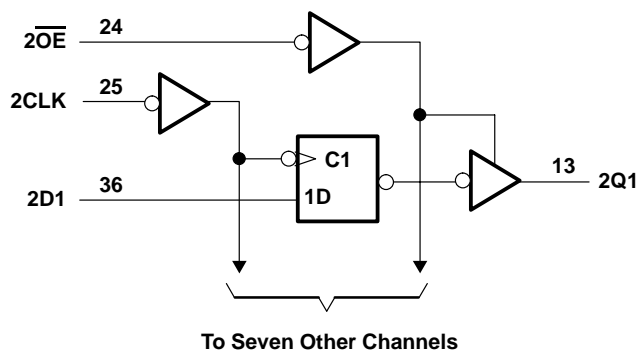
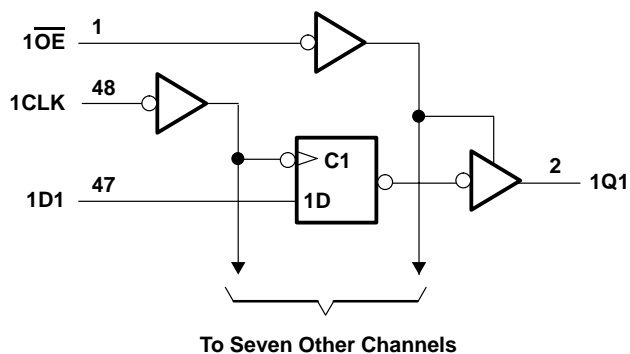
16-BIT D-TYPE EDGE-TRIGGERED FLIP-FLOP WITH 3-STATE OUTPUTS

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FUNCTION TABLE
(each section)

| INPUTS | | | OUTPUT |
|-----------------|--------|---|--------|
| \overline{OE} | CLK | D | Q |
| L | ↑ | H | H |
| L | ↑ | L | L |
| L | H or L | X | Q_0 |
| H | X | X | Z |

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|--|
| Supply voltage range, V_{CC} | -0.5 V to 7 V |
| Input voltage range, V_I (see Note 1) | -0.5 V to $V_{CC} + 0.5$ V |
| Output voltage range, V_O (see Note 1) | -0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) | ± 20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) | ± 24 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ± 24 mA |
| Continuous current through V_{CC} or GND | ± 260 mA |
| Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DL package | 1.2 W |
| Storage temperature range, T_{stg} | -65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

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recommended operating conditions (see Note 3)

| | | MIN | NOM | MAX | UNIT |
|-----------------|------------------------------------|-----|-----|-----------------|------|
| V _{CC} | Supply voltage (see Note 4) | 4.5 | 5 | 5.5 | V |
| V _{IH} | High-level input voltage | 2 | | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | V |
| V _I | Input voltage | 0 | | V _{CC} | V |
| V _O | Output voltage | 0 | | V _{CC} | V |
| I _{OH} | High-level output current | | | -16 | mA |
| I _{OL} | Low-level output current | | | 16 | mA |
| Δt/Δv | Input transition rise or fall rate | 0 | | 10 | ns/V |
| T _A | Operating free-air temperature | -40 | | 125 | °C |

NOTES: 3. All unused inputs of the device must be at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

4. All V_{CC} and GND pins must be connected to the proper-voltage power supply.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} | T _A = 25°C | | | MIN | MAX | UNIT |
|---------------------------------------|---|-----------------|-----------------------|------|------|-----|-----|------|
| | | | MIN | TYP | MAX | | | |
| V _{OH} | I _{OH} = -50 μA | 4.5 V | 4.4 | | 4.4 | | V | |
| | | 5.5 V | 5.4 | | 5.4 | | | |
| | I _{OH} = -16 mA | 4.5 V | 3.94 | | 3.7 | | | |
| | | 5.5 V | 4.94 | | 4.7 | | | |
| I _{OH} = -24 mA [†] | 5.5 V | | | 3.85 | | | | |
| V _{OL} | I _{OL} = 50 μA | 4.5 V | | | 0.1 | 0.1 | V | |
| | | 5.5 V | | | 0.1 | 0.1 | | |
| | I _{OL} = 16 mA | 4.5 V | | | 0.36 | 0.5 | | |
| | | 5.5 V | | | 0.36 | 0.5 | | |
| I _{OL} = 24 mA [†] | 5.5 V | | | | 0.5 | | | |
| I _I | V _I = V _{CC} or GND | 5.5 V | | | ±0.1 | ±1 | μA | |
| I _{OZ} | V _O = V _{CC} or GND | 5.5 V | | | ±0.5 | ±10 | μA | |
| I _{CC} | V _I = V _{CC} or GND, I _O = 0 | 5.5 V | | | 8 | 160 | μA | |
| ΔI _{CC} [‡] | One input at 3.4 V, Other inputs at GND or V _{CC} | 5.5 V | | | 0.9 | 1 | mA | |
| C _i | V _I = V _{CC} or GND | 5 V | | 4.5 | | | pF | |
| C _o | V _O = V _{CC} or GND | 5 V | | 12 | | | pF | |

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

[‡] This is the increase in supply current for each input that is at one of the specified TTL-voltage levels rather than 0 V to V_{CC}.



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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

| | | T _A = 25°C | | MIN | MAX | UNIT |
|--------------------|------------------------------|-----------------------|-----|-----|-----|------|
| | | MIN | MAX | | | |
| f _{clock} | Clock frequency | 0 | 65 | 0 | 65 | MHz |
| t _w | Pulse duration | CLK low | 7.5 | 7.5 | | ns |
| | | CLK high | 4.5 | 4.5 | | |
| t _{su} | Setup time, data before CLK↑ | 6.5 | | 6.5 | | ns |
| t _h | Hold time, data after CLK↑ | 1 | | 1 | | ns |

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

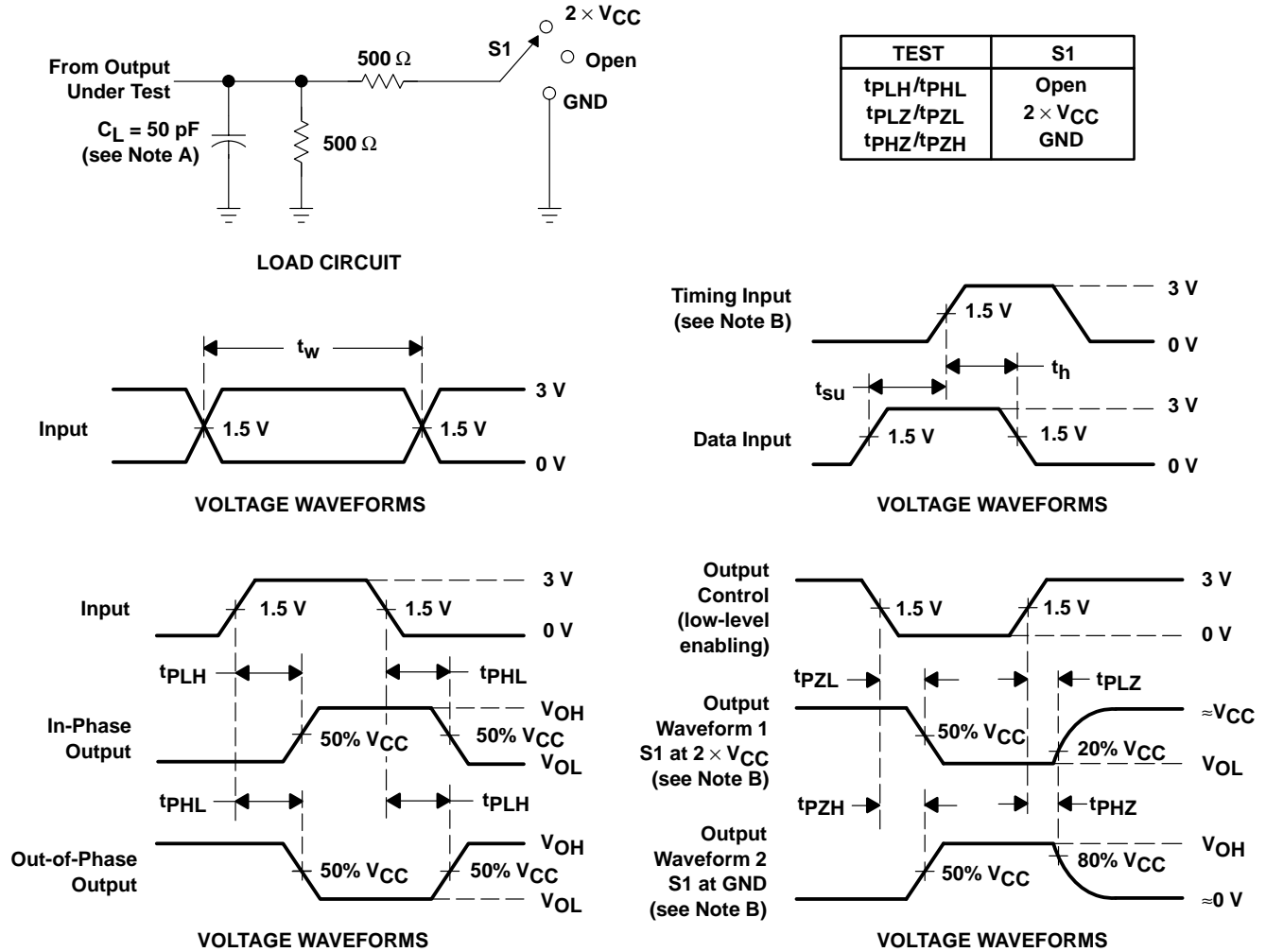
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | T _A = 25°C | | | MIN | MAX | UNIT |
|------------------|--------------|-------------|-----------------------|-----|------|-----|------|------|
| | | | MIN | TYP | MAX | | | |
| f _{max} | | | 65 | | | 65 | | MHz |
| t _{PLH} | CLK | Q | 5.1 | 8.8 | 10.9 | 5.1 | 13.2 | ns |
| t _{PHL} | | | 5.3 | 8.8 | 10.9 | 5.3 | 13.1 | |
| t _{PZH} | OE | Q | 3.7 | 8.4 | 10.5 | 3.7 | 12.7 | ns |
| t _{PZL} | | | 4.4 | 9.7 | 11.9 | 4.4 | 14.3 | |
| t _{PHZ} | OE | Q | 5.4 | 7.9 | 9.8 | 5.4 | 10.9 | ns |
| t _{PLZ} | | | 4.9 | 7.2 | 9.1 | 4.9 | 10.2 | |

operating characteristics, V_{CC} = 5 V, T_A = 25°C

| PARAMETER | | TEST CONDITIONS | | TYP | UNIT |
|-----------------|---|------------------|-----------------------------------|-----|------|
| C _{pd} | Power dissipation capacitance per flip-flop | Outputs enabled | C _L = 50 pF, f = 1 MHz | 52 | pF |
| | | Outputs disabled | | 38 | |



PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
 D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|------------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| SN74ACT16374QDLREP | Active | Production | SSOP (DL) 48 | 1000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | ACT16374QEP |
| SN74ACT16374QDLREP.A | Active | Production | SSOP (DL) 48 | 1000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | ACT16374QEP |
| V62/03603-01XE | Active | Production | SSOP (DL) 48 | 1000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | ACT16374QEP |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74ACT16374QDLREP | SSOP | DL | 48 | 1000 | 330.0 | 32.4 | 11.35 | 16.2 | 3.1 | 16.0 | 32.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS

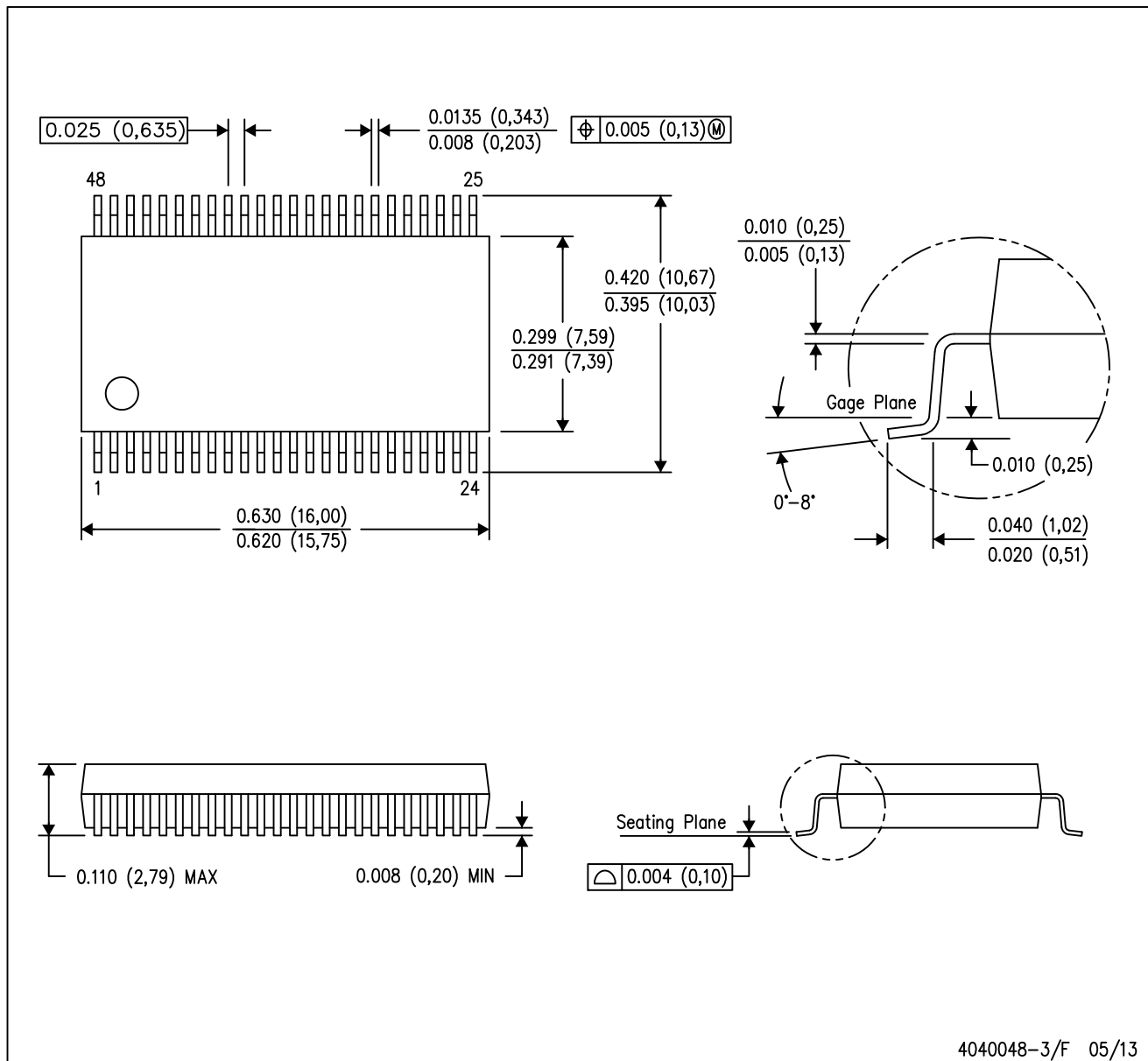

*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ACT16374QDLREP | SSOP | DL | 48 | 1000 | 356.0 | 356.0 | 53.0 |

MECHANICAL DATA

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MO-118

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